## T11, Fibre Channel Interfaces Liaison Report

June, 2003

TC T11 last met June 5, 2003.

67 representatives of 56 organizations attended. The total number of member organizations is 57.

A draft letter to the Homeland Security Standards Panel was approved pointing out the relevance of certain T11 standards.

T11 took all the requested actions of its TGs as described below.

T11 Annual Report scheduled for July 16, 2003.

Letter Ballot recommendation on RapidIO for ISO was requested.

• TG T11.2 - FC physical layer TG:

Membership is 40 companies.

Projects in development include FC-MJSQ, FCSM-2, FC-PI-2, and FC-PI-3.

Optical activities of special interest included 1310 nm 1 km link, Electronic Dispersion Control (EDC). Copper activities of special interest included 2, 4, and 8 Gb/s use of SCA-2 connectors.

A total of 9 teleconferences were authorized to: continue development on EDC, resolve FC-MJSQ comments, FC-PI-2, and additional optical variants for FC-PI-3.

The FC-PI-2 document revision 4.0, when available, was forwarded to T11 for letter balloting.

 T11.3 - FC logical / protocol TG Membership is 47 companies. Projects in the publication stage include: FC-BB-2

Projects in the approval stage include: FC-SB-3, FC-FS, FC-GS-4, and FC-SW-3.

Projects in the development phase include: FC-FS-2, FC-AE-2, FC-BB-3, FC-LS, FC-DA, FC-MI-2, and FC-SP.

A project proposal for FC-BB-3 was forwarded.

A fabric expansion study group was commissioned.

IPv6 over FC comment review was completed and the resulting document was commended to IETF as a submission from Claudio DeSanti.

A conformance document process was approved to allow broader public examination of the SCD documents.

Interim adhocs for FC-SW-3 and FC-DA in Colorado Springs, July 8.

T11.5, storage network management TG
 Membership is 34 companies.

The FC-SWAPI project is in approval.

The FC-HBA, SM-MM, and SM-AMD projects are in development.

A project proposal for FAIS was forwarded.

An interim adhoc for FAIS in Colorado Springs, July 9.

2 interim teleconferences were authorized for SM-MM and SM-AMD

T11 TC and TG liaisons

Liaisons are presently distributed as follows:

T11: INCITS, T10, SNIA, FCIA

T11.2: T11, SFF SSWG on Transceivers, SFF/HSS, FCIA, 10GBASE-CX4.

T11.3: T11, T10, IETF IPS, FCIA, T1X1.

T11.5: T11, DMTF, IETF, SNIA.

Next meeting

T11 Plenary Week, August 11-15, 2003, in Cambridge, MA. Meeting map and hotel information are available at www.t11.org.

 For more detailed information and adhoc meeting schedule, see minutes and supporting documents at www.t11.org.